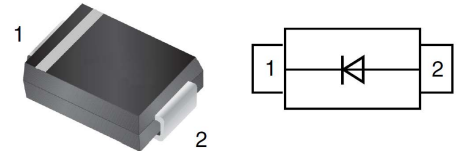


Super Fast Surface Mount Rectifier in DO-214AB/SMC

Features

- For surface mounted application
- Glass passivated junction chip
- Built-in strain relief
- ideal for automated placement
- Superfast recovery time for high efficiency



Mechanical Data

- **Case:** JEDEC DO-214AB(SMC)molded plastic
Lead free; RoHS compliant
- **Molding Compound Flammability Rating:**
UL 94 V-0
- **Terminals:** High temperature soldering guaranteed:
260 °C/10 sec. at terminals

Maximum Ratings And Electrical Characteristics

Ratings at 25° C ambient temperature unless otherwise specified.
Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	Symbols	ES3A	ES3B	ES3D	ES3G	ES3J	ES3K	ES3M	Units	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts	
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	Volts	
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	Volts	
Maximum average forward rectified current See Fig. 1 @ $T_L=90^{\circ}C$	$I_{(AV)}$	3.0							Amp	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	100.0							Amps	
Maximum instantaneous forward voltage @ 1.0A	V_F	0.95			1.25	1.7			Volts	
Maximum DC reverse current at rated DC blocking voltage	I_R	@ $T_A=25^{\circ}C$			10.0			@ $T_A=125^{\circ}C$	500	μA
Maximum reverse recovery time (Note 1)	t_r	35							nS	
Typical junction capacitance (Note 2)	C_J	50							pF	
Typical thermal resistance (Note 3)	$R_{\theta JA}$ $R_{\theta JL}$				47.0			12.0	$^{\circ}C/W$	
Operating temperature range	T_J	-55 to +150							$^{\circ}C$	
Storage temperature range	T_{STG}	-55 to +150							$^{\circ}C$	

- Notes:**
1. Reverse Recovery Test Conditions: $I_F=0.5A$, $I_R=1.0A$, $I_{RR}=0.25A$
 2. Measured at 1 MHz and Applied $V_R=4.0$ Volts
 3. Thermal Resistance from Junction to Ambient and from Junction to Lead Mounted on P.C.B. with 0.2" x 0.2" (5.0 x 5.0 mm) Copper Pad Areas

Typical Characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Figure 1. Forward Current Derating Curve

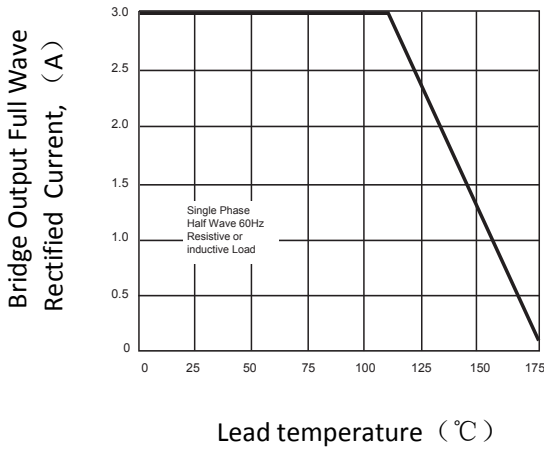


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

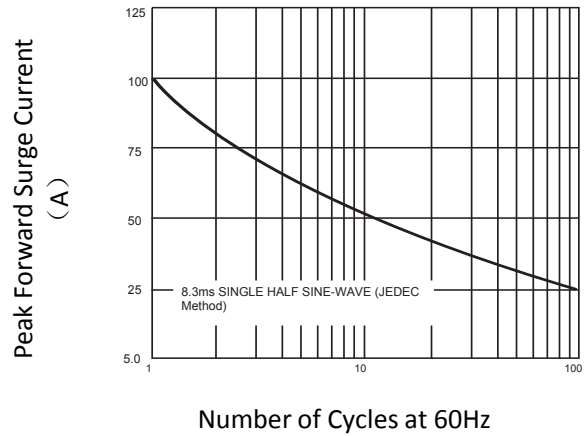


Figure 3. Typical Instantaneous Forward Characteristics

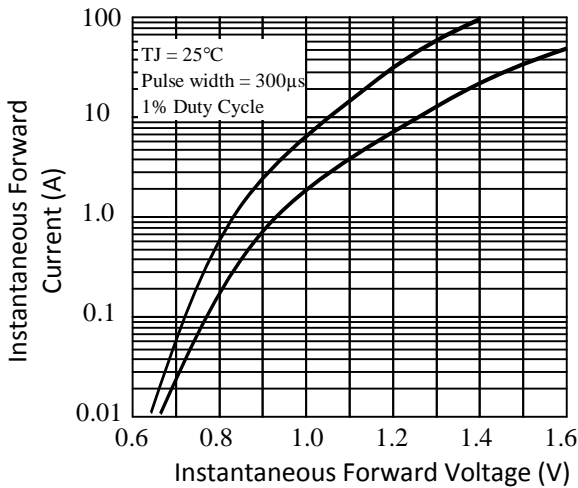


Figure 4. Typical Reverse Characteristics

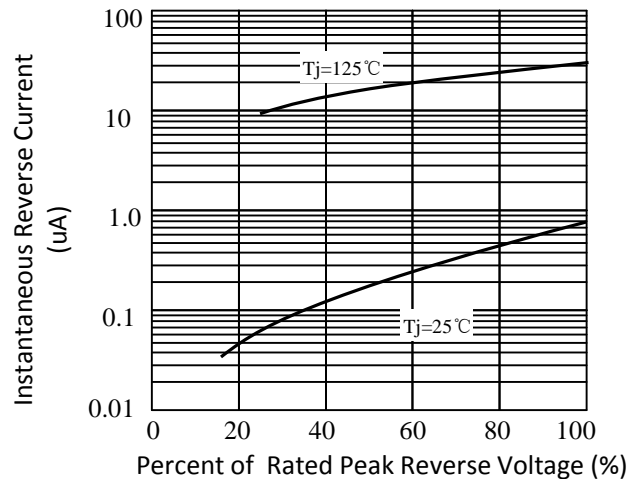


Figure 5. Typical Junction Capacitance

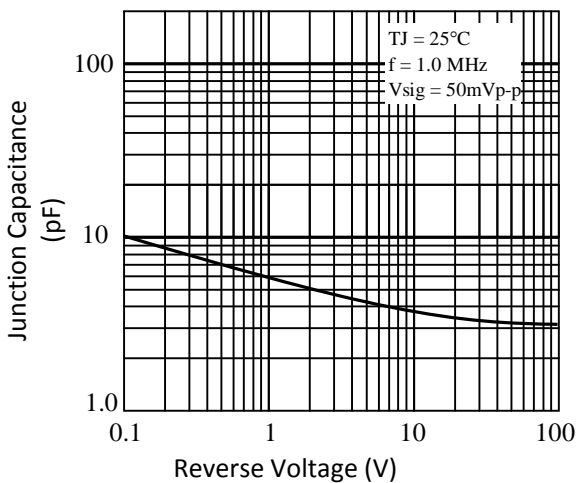
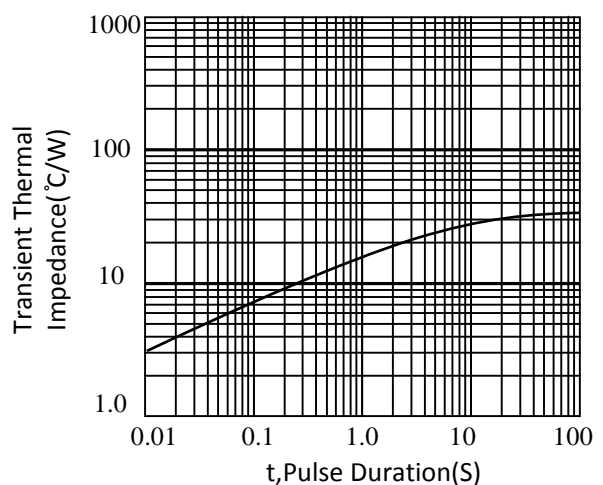
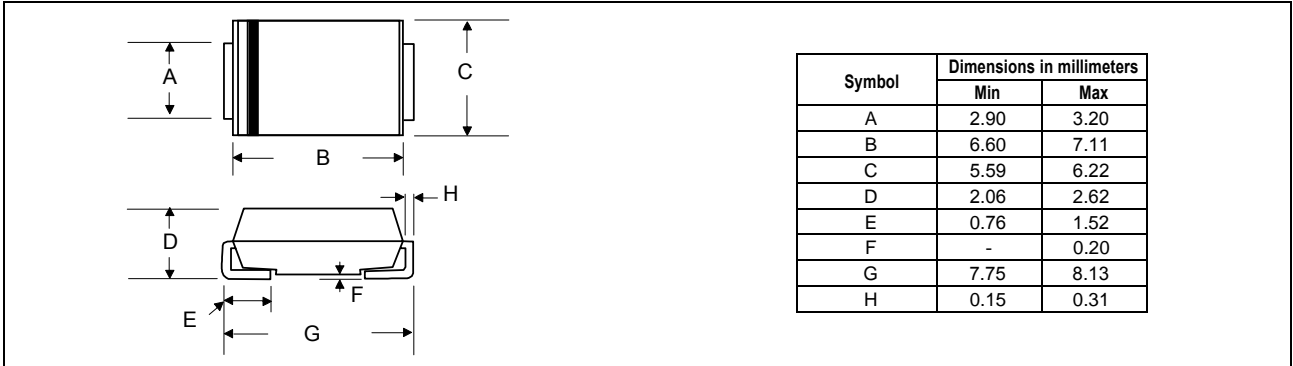
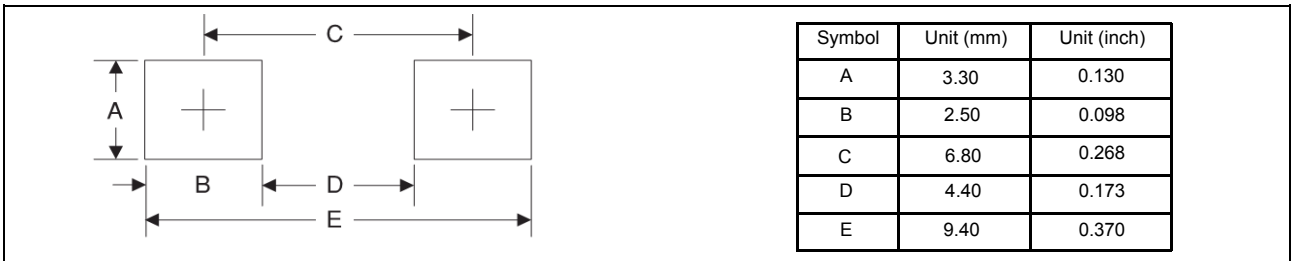
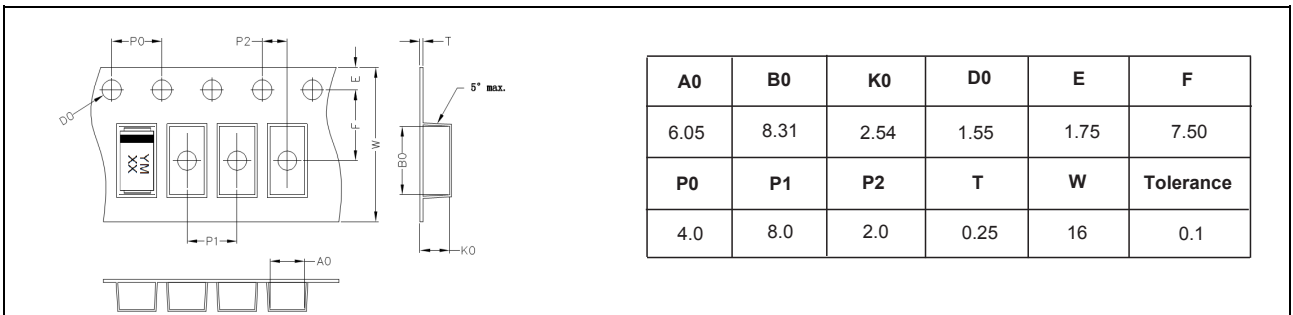


Figure 6. Typical Transient Thermal Impedance



Package Dimensions

PAD Dimensions

Packing Information

Ordering information

Order code	Package	Packaging option	Base quantity	Packaging specification
ES3A thru ES3M	DO-214AB/SMC	Tape and reel	3000pcs / reel	EIA STD RS-481

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